Beclaration, Power Of Attorney and Petition

Page 1 of 3

WE (1) the undersigned inventor(s), hereby declare(s) that:

My residence, post office address and citizenship are as stated below next to my name,

COPPER SMELTING	G PROCESS		
the specification of which			
☐ is attached he	reto.		
🛭 was filed on	March 31, 1993	as	
Attorney Do ХүүХХХИХИ	ocket No. *XXXX 834-066-	-O CIP	
and amended	on	·	
□ was filed as P	CT international appli	cation	
Number			
on		,	
and was amer	nded under PCT Article	: 19	
on		(if applicable).	
we (I) acknowledge the dudefined in Section 1.56 of Ti We (I) hereby claim foreig foreign application(s) for pat	tims, as amended by an ety to disclose informat tle 37 Code of Federal on priority benefits und tent or inventor's certif	and understand the contents of y amendment referred to above. ion material to the examination Regulations. er Section 119 of Title 35 Unite licate listed below and have also the having a filing date before that	of this application as d States Code, of any identified below any
Application No.	Country	Day/Month/Year	Priority Claimed
Patent 2-314671	Japan	20 November 1990	M Yes D No

20 November 1990

20 November 1990

20 November 1990

Japan

Japan

Patent 2-314675

Patent 2-314682

☑ Yes □ No

☐ Yes ☐ No

☑ Yes

Yes

□ No

□ No

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We (I) hereby claim the benefit under Section 120 of Title 35 United States Code, of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Section 112 of Title 35 United States Code, We (I) acknowledge the duty to disclose material information as defined in Section 1.56(a) of Title 37 Code of Federal Regulations, which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

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And we (I) hereby appoint: Norman F. Oblon, Registration Number 24,618; Marvin J. Spivak, Registration Number 24,913; C. Irvin McClelland, Registration Number 21,124; Gregory J. Maier, Registration Number 25,599; Arthur I. Neustadt, Registration Number 24,854; Robert C. Miller, Registration Number 25,357; Richard D. Kelly, Registration Number 27,757; James D. Hamilton, Registration Number 28,421; Eckhard H. Kuesters, Registration Number 28.870; Robert T. Pous, Registration Number 29,099; Charles L. Gholz, Registration Number 26:395; Vincent J. Sunderdick, Registration Number 29,004; William E. Beaumont, Registration Number 30,996; Steven B. Kelber, Registration Number 30,073; Stuart D. Dwork, Registration Number 31,103; Robert F. Gnuse, Registration Number 27,295; Jean-Paul Lavalleye, Registration Number 31,451: William B. Walker, Registration Number 22,498: Timothy R. Schwartz, Registration Number 32,171; Richard H. Stern, Registration Number 20,380; and John H.O. Clarke, Registration Number 17,373, our (my) attorneys, with full powers of substitution and revocation, to prosecute this application and to transact all business in the Patent Office connected therewith; and we (I) hereby request that all correspondence regarding this application be sent to the firm of OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C., whose Post Office Address is: Fourth Floor, 1755 Jefferson Davis Highway, Arlington, Virginia 22202.

We (I) declare that all statements made herein of our (my) own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Moto Goto		
NAME OF FIRST SXXXX INVENTOR		
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Signature of Inventor

April 30, 1993

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Page 3 of 3 Declaration

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NAME OF THE IN JOINT INVENTOR			
Ciarana (I	Citizen of:		
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